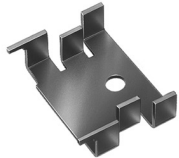


Data sheet Product FK 211 32 MI



Board Level heatsinks>Finger shaped heatsinks
for semiconductor-design SOT 32

Features

material:	aluminium
for transistor:	SOT 32
width:	25.4 mm
height:	8 mm
length:	21 mm
thermal resistance:	25 K/W
surface:	solderable surface
version:	<ul style="list-style-type: none"> • with perforation • with solder lug for vertical installation

Technical Drawing

